

PREDICTION OF MECHANICAL, ELECTRIC, AND THERMAL PROPERTIES OF COPPER ALLOYS BASED ON COMPOSITION AND PROCESSING USING MACHINE LEARNING

Jaka Fajar Fatriansyah, Yossi Andreano Department of Metallurgical and Materials Engineering

INTRODUCTION

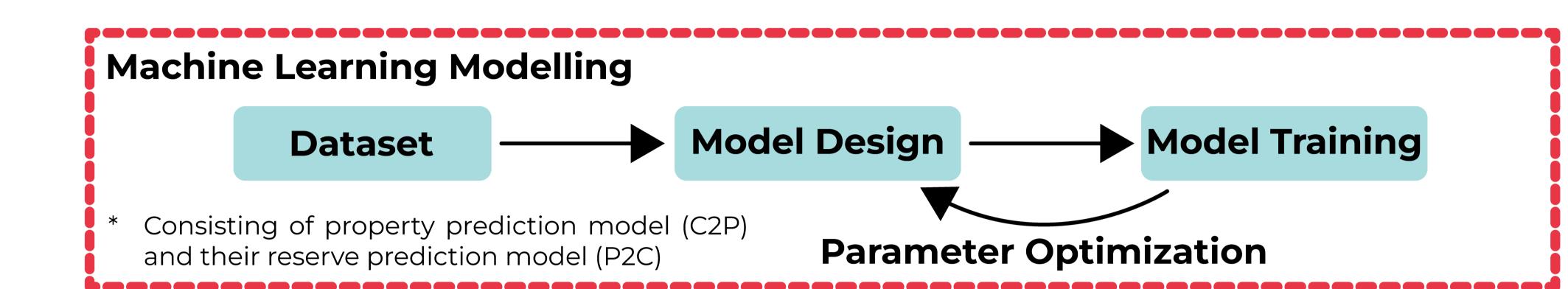
Problems

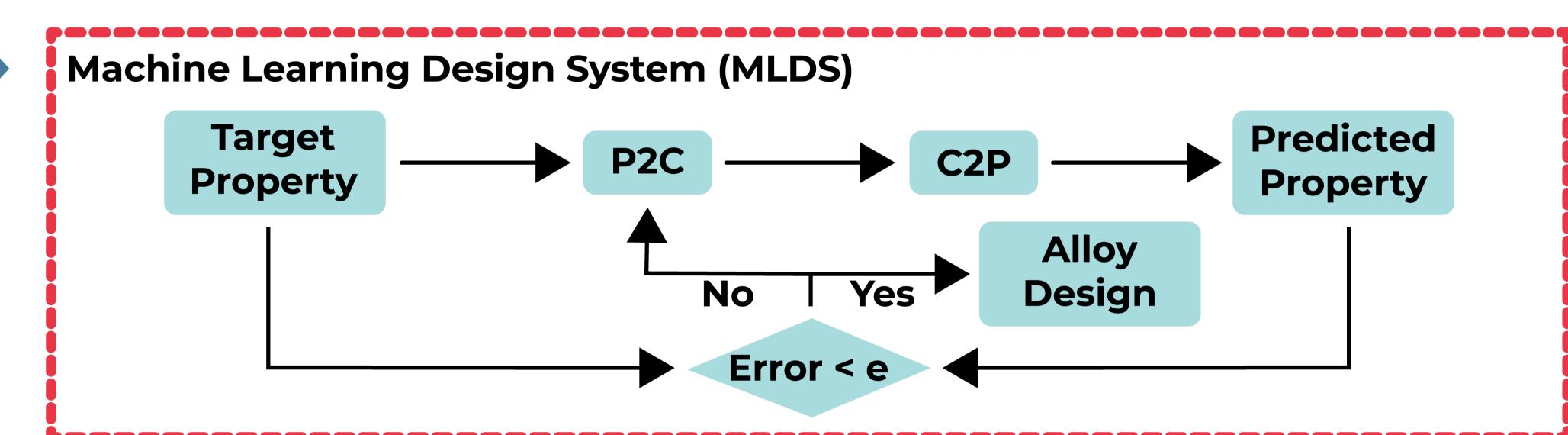
- of **leadframes** requires a complex set of specifications, including **high** application conductivity, and low thermal expansion coefficient to strength, high performance.
- Discovering copper materials that achieve this combination of properties through experimental method involves significant costs and is time-consuming.

Objective

Develop ML models for predicting and reverse-predicting the tensile strength, electrical conductivity, and thermal expansion coefficient of copper alloys based on their chemical composition and processing methods and to assess the performance of these models in selecting optimal copper alloy materials.

METHODOLOGY





RESULT

- From the six trained models (KNN, RF, ExtraTrees, Catboost, XGB, and BPNN), the two best C2P and P2C models obtained are **BPNN** and **XGB** as shown in Figure 1.
- MLDS XGB shows lower fluctuations compared to MLDS BPNN and P2C BPNN in providing recommendations for copper alloy composition and processing, spesifically referencing C41300 material as shown in Figure 2.
- MLDS XGB can be used to recommend new copper alloys for leadframe applications that are in line with the literature as shown in Table 1.

Fig 1. The performance of the best C2P and P2C models

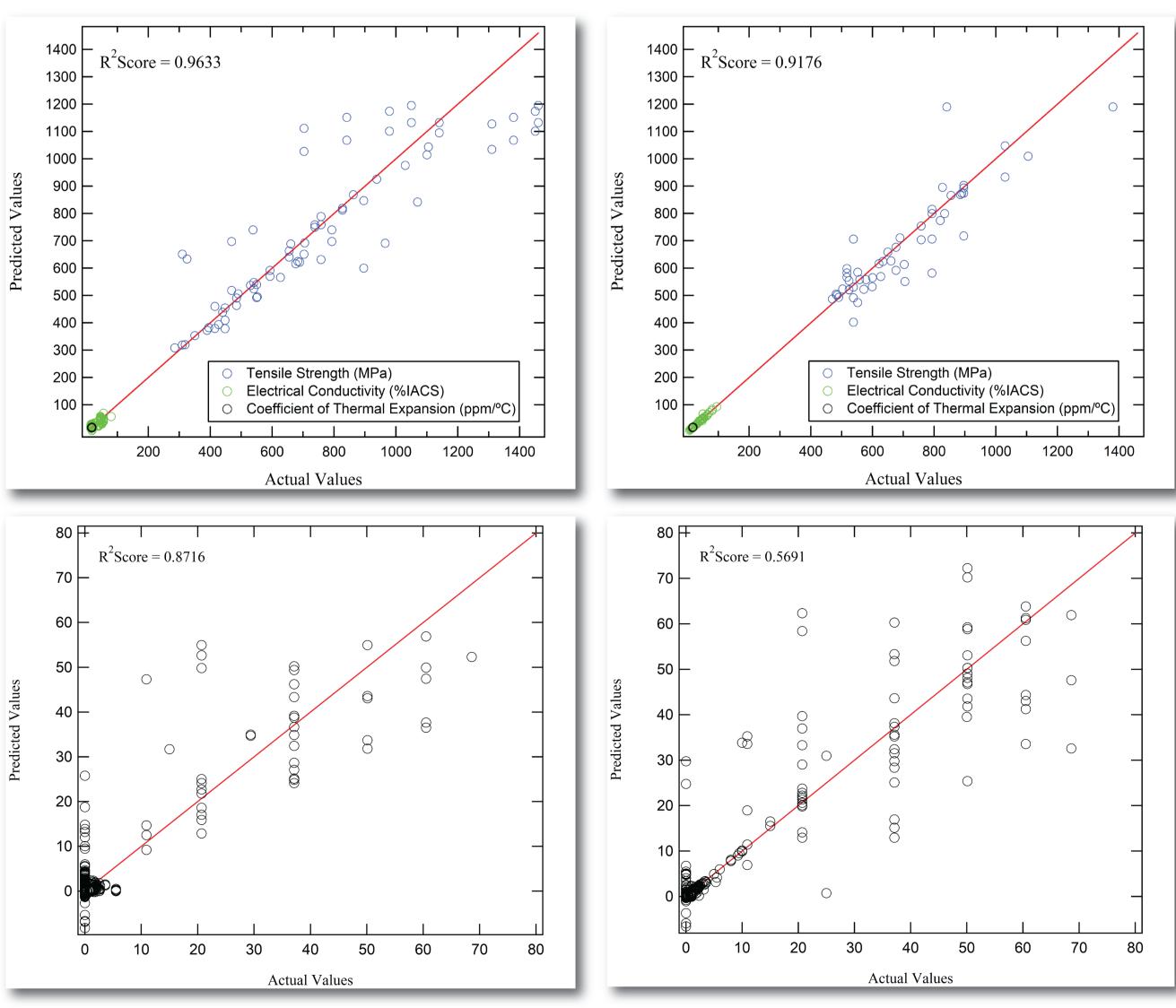
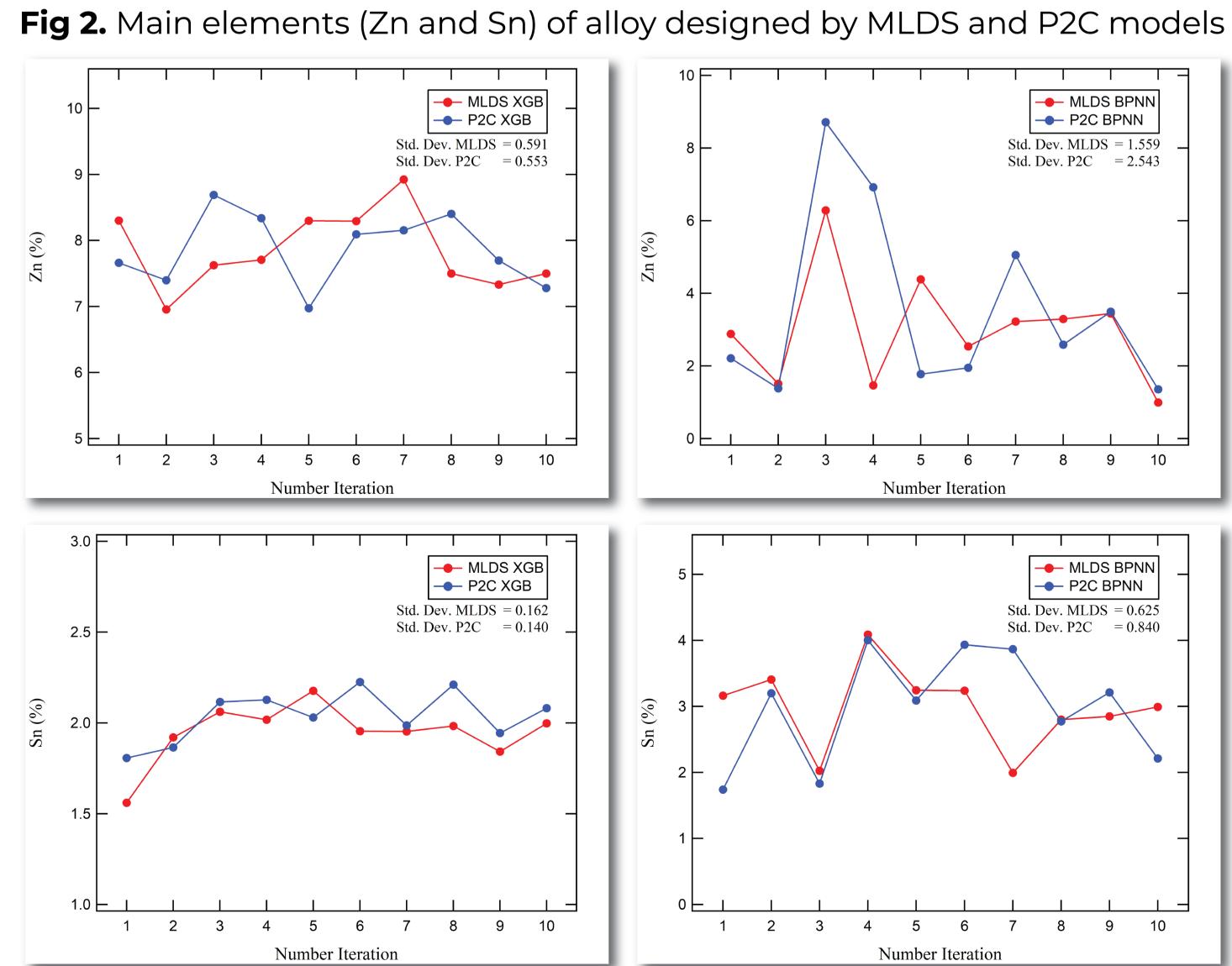


Table 1. Design Result and Verification

Target	MLDS	Experimental	Experimental
	Result	Design	Result
575 MPa 85% IACS 17 ppm/°C	Cu-0.21Fe-0.16Zr-0.52Cr -0.03Ti-0.04Ag (C) Solution treatment, 45% CR, and aging (P)	Cu-0.15Zr-0.5Cr-0.1Ag (C) Solution treatment, 80% CR, and aging (P)	570 MPa 86% IACS



BPNN and XGB are the two best models for C2P and P2C, but the performance of MLDS XGB in recommending copper composition and processing is significantly better.

CONGLUSION